PCT

WORLD INTELLECTUAL PROPERTY ORGANIZATION International Bureau



INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification 7:
H01R 4/68

A1
(11) International Publication Number: WO 00/14827
(43) International Publication Date: 16 March 2000 (16.03.00)

(21) International Application Number: PCT/US99/20526

(22) International Filing Date: 9 September 1999 (09.09.99)

(30) Priority Data: 9819545.6 9 September 1998 (09.09.98) GB

(71) Applicant (for all designated States except IS US): BICC GENERAL UK CABLES LIMITED [GB/GB]; Hall Lane, Prescot, Merseyside L34 5TJ (GB).

(71) Applicant (for IS only): BICC GENERAL CABLE IN-DUSTRIES, INC. [US/US]; 4 Tesseneer Drive, Highland Heights, KY 41076 (US).

(72) Inventors; and

(75) Inventors/Applicants (for US only): SPILLER, Darren, Michael [GB/GB]; 49 Alwyn Gardens, Upton, Chester, Cheshire CH2 1LW (GB). WEBB, Michael, Patrick [GB/GB]; 56 Kingfisher Way, Marchwood, Southampton SO40 4XS (GB). BEDUZ, Carlos [GB/GB]; 19 Kitchener Road, Portswood, Southampton SO17 3SF (GB). YANG, Yifeng [GB/GB]; 5 Kitchener Road, Portswood, Southampton SO17 3SF (GB).

(74) Agents: GREENBAUM, Michael, C. et al.; Blank Rome Comisky & McCauley LLP, Suite 1000, 900 17th Street, N.W., Washington, DC 20006 (US).

(81) Designated States: AE, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CR, CU, CZ, DE, DK, DM, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, UA, UG, US, UZ, VN, YU, ZA, ZW, ARIPO patent (GH, GM, KE, LS, MW, SD, SL, SZ, UG, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG).

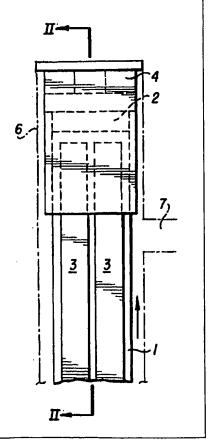
Published

With international search report. With amended claims.

(54) Title: SUPERCONDUCTING LEADS

(57) Abstract

A superconducting lead comprises a supporting board (1) with at least one superconducting tape (3) adhered to it and extending from one terminal area of the lead to another. Respective metal end-fittings soldered to the superconducting tape (3) at each of its ends, and in each of the terminal areas at least one metal insert is bonded to the board (1) and also soldered to the corresponding one of the said end-fittings, so relieving the tapes (3) of mechanical stress. The board (1), or each of them, is preferably flat and may support two or more superconducting tapes (3) coplanar with one another on one or on each of its major faces. The metal inserts are preferably of copper and may be made by removing most of the copper cladding from a commercially available circuit board (1).



FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AL	Albania	ES	Spain ·	LS	Lesotho	SI	Slovenia
AM	Armenia	FI	Finland	LT	Lithuania	SK	Slovakia
AT	Austria	FR	France	LU	Luxembourg	SN	Senegal
ΑÜ	Australia	GA	Gabon	LV	Latvia	SZ	Swaziland
AZ	Azerbaijan	GB	United Kingdom	MC	Monaco	TD	Chad
BA	Bosnia and Herzegovina	GE	Georgia	MD	Republic of Moldova	TG	Togo
BB	Barbados	GH	Ghana	MG	Madagascar	TJ	Tajikistan
BE	Belgium	GN	Guinea	MK	The former Yugoslav	TM	Turkmenistan
BF	Burkina Faso	GR	Greece		Republic of Macedonia	TR	Turkey
BG	Bulgaria	HU	Hungary	ML	Mali	TT	Trinidad and Tobago
BJ	Benin	IE	Ireland	MN	Mongolia	UA	Ukraine
BR	Brazil	IL	Israel	MR	Mauritania	· UG	Uganda
BY	Belarus	IS	Iceland	MW	Malawi	US	United States of America
CA	Canada	IT	Italy	MX	Mexico	UZ	Uzbekistan
CF	Central African Republic	JP	Japan	NE	Niger	VN	Viet Nam
CG	Congo	KE	Kenya	NŁ	Netherlands	YU	Yugoslavia
CH	Switzerland	KG	Kyrgyzstan	NO	Norway	ZW	Zimbabwe
CI	Côte d'Ivoire	KP	Democratic People's	NZ	New Zealand		
CM	Cameroon		Republic of Korea	PL	Poland		
CN	China	KR	Republic of Korea	PT	Portugal		
CU	Cuba	KZ	Kazakstan	RO	Romania		
CZ	Czech Republic	LC	Saint Lucia	RU	Russian Federation		
DE	Germany	LI	Liechtenstein	SD	Sudan		
DK	Denmark	LK	Sri Lanka	SE	Sweden		
EE	Estonia	LR	Liberia	SG	Singapore		

WO 00/14827 PCT/US99/20526

Superconducting Leads

This invention relates to superconducting leads, primarily for use as "current leads", meaning (as customary among superconductivity experts) leads for conveying current to a apparatus operating at a cryogenic temperature from a source at a substantially higher temperature. In most applications the cryogenic temperature will be a "liquid helium" temperature in the vicinity of 4K and the higher temperature will be liquid nitrogen temperature (around 77K) or lower.

Superconducting current leads are preferred, when the level of the higher temperature makes it possible, both because their own losses electrical are smaller than for comparable metal current leads and also because they can have substantially higher thermal resistance and often appreciably reduce overall refrigeration losses of the apparatus.

Superconducting current leads have been made with "bulk" ceramic superconductor powder, either compressed and sintered into self-supporting blocks or packed into a silver (or 20 silver alloy) tube and suitably compressed. They have also been made with ceramic superconductors in tape form, as they would now normally be used for winding coils or making power cables. However, "bulk" superconductor leads are brittle, mechanically weak, and are liable to be destroyed if fault 25 conditions lead to loss of superconductivity; superconducting tapes are self-protecting from such faults as the silver/silver alloy content is sufficient to carry the current as a normal conductor for short periods and they are flexible and somewhat more resistant to thermal cycling 30 shock, but they still have little inherent strength, and as the thermal stresses are necessarily rather large in a current lead operating with its ends at very different temperatures and subject at least occasionally to cycles to room temperature, they need mechanical support.

One satisfactory way of giving mechanical support is to bond the tapes with a suitable adhesive to support (this may

WO 00/14827 2 PCT/US99/20526

be of various cross-sections but our own preference is that it should be flat and for convenience we refer to it as a "board") of a resin-bonded fibre glass or other material having thermal expansion characteristics reasonably similar 5 to those of the tape. Even then, substantial stresses arise at the terminations, where the tapes will normally be connected to a solid copper conductor by soldering, and it is the applicants' experience that this may result in partial or complete failure of the soldered connection and that, even 10 under favourable conditions, the contact resistance at the two terminations may account for as much as a fifth of the total losses in the current lead.

It is an object of the invention to provide a superconducting lead suitable for use as a current lead in which the terminations are secure and the terminal contact resistance stabilised at a low value.

The superconducting lead in accordance with the invention comprises a supporting board with at least one superconducting tape adhered to it and extending from one 20 terminal area of the lead to another; respective metal endfittings soldered to the superconducting tape at each of its ends; and in each of the terminal areas at least one metal insert bonded to the said board and also soldered to the corresponding one of the said end-fittings.

In this way, longitudinal mechanical stresses can be carried from the end-fittings directly to the board, bypassing and so relieving of stress the soldered joints to the tape.

There may be more than one board, and the board, or each 30 board as the case may be, may support any convenient number of superconducting tapes. Preferably the board, or each of them, is flat and supports two or more tapes coplanar with one another on one or on each of its major faces, so that the whole flat side and both edges of each tape are accessible 35 for soldering without requiring a complex shape for the terminal member. However, two or three tapes (or more, at an

WO 00/14827 3 PCT/US99/20526

increasing penalty) can be superposed on one another if compactness is of over-riding importance.

The metal inserts, as well as the terminal members, are preferably of copper, especially high-condutivity

5 "oxygen-free" copper(and the terminal members preferably plated with gold or silver). They are conveniently simple rectangular strips along (or parallel and close to) the appropriate edges of the board. Strips only a few millimetres wide are effective and considerered adequate, but if desired they could be wide enough to facilitate reinforcement by drilling to accommodate a transverse pin of metal or other hard material.

Suitable boards with copper very strongly bonded over substantially its whole area is readily available as it is 15 widely used to make circuit boards for electronics applications. One suitable board is a resin-bonded fibreglass board clad with about 35µm of copper and coated with a positive working photoresist to comply with BS 4581, sold under the trademark "Fotoboard" and grade code "FR4" by Mega 20 Electronics. Copper can be removed, except for the required inserts, by imagewise exposure to UV light, development and etching (for which the board is designed) or by machining. It is the applicants' understanding that this board is made by in-situ curing of the fibre-bonding resin on a pre-formed and 25 specially prepared (etched) copper sheet.

Preferably the (or each) superconducting tape is bonded to the board over the whole area of the tape. A suitable adhesive is manufactured by Grace Specialty Polymers and sold in the United Kingdom by Emerson Cumming (UK) Ltd under the trademark "Eccobond 286" and is understood to be an epoxy resin product filled with an oxide of aluminium or of zirconium to improve matching of thermal expansion characteristics.

The lead may incorporate two or more boards with

35 superconducting tapes as described, preferably but not
necessarily arranged parallel to one another; they may be

WO 00/14827 4 PCT/US99/20526

alike (typically resulting in a rectangular cross-section) or may differ in width (with or without the number of tapes differing), for example to give an overall round cross-section.

Silver/silver alloy clad ceramic superconductor tapes can be successfully soldered to the terminal members by a suitable solder; we prefer solders comprising (by weight) equal parts of lead and bismuth or 2 parts of lead, 5 parts of bismuth and 3 parts of tin, but ordinary tin/lead eutectic solder can be used.

If it is desired that the lead should be "vapour-cooled", the superconducting tape(s) is/are preferably coated to protect from contact with coolant; Nova Tran Ltd offer a custom coating service under the trademark "Parylene" and for this coating a thickness of about 30-40 µm is recommended; but other coatings can be used. The applicants do not know whether the process operated by Nova Tran Ltd (described as a gas phase deposition) resembles the technique using pyrolysed poly-para-xylylene described in US patent 4508760. In most such cases a tubular shroud with appropriate apertures for vapour flow will be added after coating.

If "vapour-cooling" is not desired, then we prefer to protect the lead by adding a closely-fitting enclosure and "potting" by introduction of a suitable hardening resin (such as Eccobond 286 referred to above) into the remaining clearances. Such enclosure is suitable made from a resinbonded fibre glass material similar to the material of the board or boards; a suitable material is sold by Tufnol Ltd under their trademark TUFNOL and the product code 10G/40.

The terminal members may project axially for external connection, but where the installation geometry permits we prefer that they project laterally, so as to accommodate the maximum length of superconductor, and thus minimise thermal conductance of the lead.

35 The invention will be further described, by way of example, with reference to the accompanying drawing in which:

WO 00/14827 5 PCT/US99/20526

Figure 1 is a partly diagrammatic elevation of an end part of one form of lead in accordance with the invention;

Figure 2 is a cross-section on the line II-II in Figure 1;
and

- 5 Figure 3 is an elevation, corresponding to Figure 1, showing an alternative form of lead in accordance with the invention and incorporating a number of independent options; this figure shows the lead in an unfinished condition, as will be explained below.
- The lead of Figures 1 and 2 is based on a narrow strip 10 of double-sided FOTOBOARD circuit board 1 with the copper layers entirely etched away except for narrow strips 2, 2 at each end (only one end is shown, the other may be identical). On each of the so exposed faces of the board superconducting 15 tapes 3 each consisting of one or more "filament" of a "high temperature" ceramic superconducting material (preferably of the BISCCO family) are adhered using Eccobond 286 lowexpansion epoxy adhesive. The end of the board is inserted in a slot in a gold-plated copper terminal member 4 and bonded 20 to it by a solder 5 consisting of equal parts by weight of lead and bismuth. This bonds securely both to the tapes 3 (providing a low-resistance electrical connection) and to the copper strips 2 (providing a strong mechanical connection from the board 1 to the terminal member 4 which is wholly 25 independent of the tapes 3).

In the case of a vapour-cooled lead, the exposed surfaces of the tapes (and optionally those of the boards as well) are thinly coated with the PARYLENE polymer coating identified above and the board enclosed by a plastics

30 shroud 6 provided with openings 7 for the flow of coolant.

Note that in this design, the terminal member 4 extends to the side of the lead proper - it is a "flag" rather than a "spade" type terminal. This permits the superconducting, and relatively thermally insulating, part of the lead to be as long as the nature of the installation permits.

The alternative design shown in Figure 3 illustrates a

WO 00/14827 6 PCT/US99/20526

number of variants, any of which may be used separately as well as together.

First, it is a "spade" type terminal with the axes of the lead and the terminal member coincident, and so is 5 suitable for direct substitution for a conventional current lead of similar shape.

Second, it comprises two similar boards 1 for increased supercurrent capacity. Higher numbers can be used, and different widths of board with the same or different numbers 10 of tapes can be used to meet design requirements: for example, three parallel boards with the central one wider than the others allows an approximation to circular crosssection, when desired.

Third, it is not intended for use with vapour cooling.

15 Consequently, instead of coating the tapes and adding an open tubular housing, the assembly is completed by a jacket made up of two components of resin-bonded fibreglass (TUFNOL 10G/40) machined to fit around the boards and terminal members with only a small clearance. The drawing 20 shows one of these jacket components 7 in place and omits the other for clarity. Once both components are in place, the remaining clearances 8 are filled with an epoxy resin by a vacuum impregnation technique to form a fully potted lead.

CLAIMS

1 A superconducting lead comprising a supporting board with at least one superconducting tape adhered to it and extending from one terminal area of the lead to another;

- 5 respective metal end-fittings soldered to the superconducting tape at each of its ends; and in each of the terminal areas at least one metal insert bonded to the said board and also soldered to the corresponding one of the said end-fittings.
- 2 A superconducting current lead as claimed in claim 1 in 10 which the board, or each of them, is flat and supports two or more superconducting tapes coplanar with one another on one or on each of its major faces.
- 3 A superconducting current lead as claimed in claim 1 or claim 2 in which the metal inserts, as well as the terminal 15 members, are of copper.
 - A superconducting current lead as claimed in claim 1 or claim 2 in which the metal inserts, as well as the terminal members, are of high conductivity oxygen-free copper.
- 5 A superconducting current lead as claimed in any one of 20 claims 1-4 in which the metal inserts are simple rectangular strips along (or parallel and close to) the appropriate edges of the board.
- 6 A superconducting current lead as claimed in any one of claims 1-5 comprising two or more said boards which differ in 25 width, with or without the number of tapes differing.
 - 7 A superconducting current lead as claimed in any one of claims 1-6 in which the superconducting tape(s) is/are coated to protect from contact with coolant.
- 8 A superconducting current lead as claimed in claim 7
 30 further comprising a tubular shroud with apertures for vapour flow.
 - 9 A superconducting current lead as claimed in any one of claims 1-6 comprising a closely-fitting enclosure and "potting" resin in remaining clearances.
- 35 10 A superconducting current lead as claimed in any one of claims 1-9 in which the terminal members project laterally.

WO 00/14827 8 PCT/US99/20526

11 A superconducting current lead substantially as described with reference to Figures 1-2; to Figure 3; or to all the Figures.

WO 00/14827 PCT/US99/20526

9

AMENDED CLAIMS

[received by the International Bureau on 07 February 2000 (07.02.00); original claims 1-11 replaced by new claims 1-12 (2 pages)]

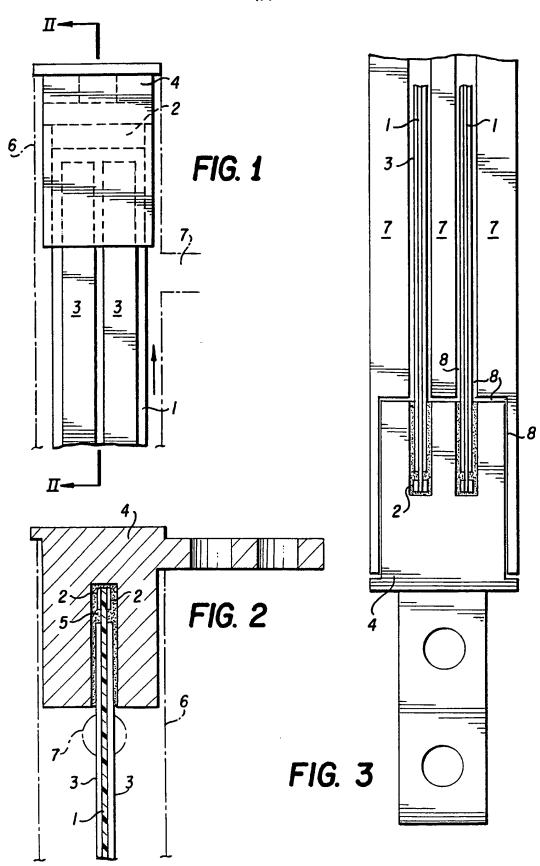
- A superconducting lead comprising a supporting board, at least one superconducting tape adhered to the supporting board, a terminal member forming a metal end-fitting soldered to the superconducting tape at an end of the supporting board and at least one metal insert bonded to the supporting board and soldered to the metal end-fitting.
- 2 A superconducting lead comprising two terminal members, a supporting board extending between the terminal members, at least one superconducting tape adhered to the supporting board, wherein each terminal member forms a metal end-fitting soldered to the superconducting tape at respective ends of the supporting board and at least one metal insert bonded to the supporting board and soldered to the respective metal end-fitting.
- 3 A superconducting current lead as claimed in claim 1 or claim 2 in which the board is flat and supports two or more superconducting tapes coplanar with one another on one or on each major face of the board.
- 4 A superconducting current lead as claimed in claims 1-3
 25 in which the metal inserts, as well as the terminal members, are of copper.
 - 5 A superconducting current lead as claimed in claims 1-3 in which the metal inserts, as well as the terminal members, are of high conductivity oxygen-free copper.

30

- A superconducting current lead as claimed in any one of claims 1-5 in which the metal inserts are rectangular strips along an edge of the board.
- 7 A superconducting current lead as claimed in any one of claims 1-6 comprising two or more said boards which differ in width, with or without the number of tapes differing.
- 8 A superconducting current lead as claimed in any one of claims 1-7 in which the superconducting tape(s) is/are coated to protect from contact with coolant.
 - 9 A superconducting lead as claimed in claim 8 further comprising a tubular shroud with apertures for vapour flow.

15

- 10 A superconducting current lead as claimed in any one of claims 1-7 comprising a closely-fitting enclosure and "potting" resin in remaining clearances.
- 20 11 A superconducting current lead as claimed in any one of claims 1-10 in which the terminal members project laterally.
- 12 A superconducting current lead substantially as described with reference to Figures 1-2; to Figure 3; or to all the 25 Figures.



SUBSTITUTE SHEET (RULE 26)

INTERNATIONAL SEARCH REPORT

Inter onal Application No PCT/US 99/20526

		1''	31/03 33/20320	
A. CLASSI IPC 7	IFICATION OF SUBJECT MATTER H01R4/68			
According to	o International Patent Classification (IPC) or to both national classifi	cation and IPC		
B. FIELDS	SEARCHED			
Minimum do IPC 7	ocumentation searched (classification system followed by classifica $H01R$	tion symbols)		
Documenta	tion searched other than minimum documentation to the extent that	such documents are included	in the fields searched	
Electronic d	lata base consulted during the international search (name of data b	ase and, where practical, sea	rch terms used)	
	ENTS CONSIDERED TO BE RELEVANT			
Category '	Citation of document, with indication, where appropriate, of the re	elevant passages	Relevant to claim No.	
A	PATENT ABSTRACTS OF JAPAN vol. 1996, no. 07,		1	
	31 July 1996 (1996-07-31) & JP 08 069827 A (TOSHIBA CORP), 12 March 1996 (1996-03-12) abstract			
А	US 5 308 831 A (FEVRIER ALAIN E 3 May 1994 (1994-05-03) column 3, line 18 - line 29; fig	·	1	
A	PATENT ABSTRACTS OF JAPAN vol. 1997, no. 08, 29 August 1997 (1997-08-29) & JP 09 097637 A (CHODENDO HATSU KIKI ZAIRYO GIJUTSU KENKYU KUMIA 8 April 1997 (1997-04-08) abstract	1),	1	
		-/		
X Furti	her documents are listed in the continuation of box C.	χ Patent family mem	bers are listed in annex.	
'A" docume consid "E" earlier of filing d "L" docume which citation 'O" docume other i	ent defining the general state of the art which is not lered to be of particular relevance document but published on or after the international date and which may throw doubts on priority claim(s) or is cited to establish the publication date of another in or other special reason (as specified) ent referring to an oral disclosure, use, exhibition or means ent published prior to the international filling date but han the pnority date claimed	"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention "X" document of particular relevance: the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art. "&" document member of the same patent family		
Date of the	actual completion of the international search	Date of mailing of the in	nternational search report	
1	5 December 1999	22/12/1999)	
Name and r	mailing address of the ISA European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Tx. 31 651 epo nl. Fax: (+31-70) 340-3016	Authorized officer Lomme 1 , A		

3

INTERNATIONAL SEARCH REPORT

Inte: Onal Application No

C (C==N==	AND DOCUMENTS CONCINCION TO OF RELEVANT	PCT/US 99/20526
Category	ation) DOCUMENTS CONSIDERED TO BE RELEVANT Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
alegury	Citation of document, with indication where appropriate, of the relevant passages	Helevant to claim No.
P	PATENT ABSTRACTS OF JAPAN vol. 1998, no. 10, 31 August 1998 (1998-08-31) & JP 10 125368 A (SUMITOMO HEAVY IND LTD), 15 May 1998 (1998-05-15) abstract	1
	US 5 453 691 A (DAVID BERND R ET AL) 26 September 1995 (1995-09-26)	
		·
;	·	

INTERNATIONAL SEARCH REPORT

information on patent family members

Inter anal Application No
PCT/US 99/20526

Patent document cited in search report		Publication date	Patent family member(s)	Publication date
JP 08069827	Α	12-03-1996	NONE	
US 5308831	А	03-05-1994	FR 2678432 A AT 127960 T DE 69204764 D DE 69204764 T DK 521374 T EP 0521374 A ES 2077300 T GR 3018219 T	31-12-1992 15-09-1995 19-10-1995 22-02-1996 05-02-1996 07-01-1993 16-11-1995 29-02-1996
JP 09097637	Α	08-04-1997	NONE	
JP 10125368	Α	15-05-1998	NONE	
US 5453691	Α	26-09-1995	DE 4227877 A EP 0584874 A JP 6177444 A	24-02-1994 02-03-1994 24-06-1994

This Page is Inserted by IFW Indexing and Scanning Operations and is not part of the Official Record

BEST AVAILABLE IMAGES

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images include but are not limited to the items checked:

BLACK BORDERS

IMAGE CUT OFF AT TOP, BOTTOM OR SIDES

FADED TEXT OR DRAWING

BLURRED OR ILLEGIBLE TEXT OR DRAWING

SKEWED/SLANTED IMAGES

COLOR OR BLACK AND WHITE PHOTOGRAPHS

GRAY SCALE DOCUMENTS

LINES OR MARKS ON ORIGINAL DOCUMENT

REFERENCE(S) OR EXHIBIT(S) SUBMITTED ARE POOR QUALITY

IMAGES ARE BEST AVAILABLE COPY.

☐ OTHER:

As rescanning these documents will not correct the image problems checked, please do not report these problems to the IFW Image Problem Mailbox.